SCOPE

This specification describes AH0603/0805/1206 high voltage and anti-sulfurated chip resistors with lead-free terminations made by thick film process.

APPLICATIONS

- Converter
- Printer equipment
- Battery charger
- Computer
- Power supply
- Car electronics

FEATURES

- AEC-Q200 qualified
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Halogen Free Epoxy
- Moisture sensitivity level: MSL 1
- IEC 62368-1:2014 safety certificate (G.10.2) issued by UL Demko for the following sizes and resistance ranges:
  - 0603: 100KΩ to 10MΩ
  - 0805: 100KΩ to 22MΩ
  - 1206: 100KΩ to 27MΩ

  *Please refer to UL certification

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

AH XXXX X X X XX XXXX L
(1) (2) (3) (4) (5) (6) (7)

(1) SIZE

0603/0805/1206

(2) TOLERANCE

D = ±0.5%
F = ±1%
J = ±5%

(3) PACKAGING TYPE

R = Paper/PE taping reel
K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

– = Base on spec

(5) TAPING REEL

07= 7 inch dia. Reel

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g.1K2, not 1K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for ordering only (Note)

Resistance rule of global part number

Resistance code rule	Example
XXKX (10 to 97.6 KΩ)	10K = 10,000 Ω 97K6 = 97,600 Ω
XXXK (100 to 976 KΩ)	100K = 100,000Ω 976K = 976,000Ω
XMXX (1 to 9.76 MΩ)	1M = 1,000,000 Ω 9M76 = 9,760,000 Ω
XXMX (10 to 16 MΩ)	10M = 10,000,000 Ω 27M = 27,000,000 Ω

ORDERING EXAMPLE

The ordering code of a AH1206 chip resistor, value 1 MΩ with ±5% tolerance, supplied in 7-inch tape reel is: AH1206JR-071ML.

NOTE

1. All our R-Chip products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / 12NC can be added (both are on customer request)

MARKING

AH0603/0805/1206

Fig. 1 Value=10 KΩ

E-24 series: 3 digits, ±5%

First two digits for significant figure and 3rd digit for number of zeros

AH0603

Fig. 2 Value=24Ω

E-24 series: 3 digits, ±0.5% & ±1%

Exception values 10/11/13/15/20/75 of E24 series

One short bar under marking letter

Fig. 3 Value=12.4 KΩ

E-96 series: 3 digits, ±0.5% & ±1%

Including values 10/11/13/15/20/75 of E24 series

First two digits for E-96 marking rule and 3rd letter for number of zeros

AH0805/1206

Fig. 4 Value=10 KΩ

Both E-24 and E-96 series: 4 digits, ±0.5% & ±1%

First three digits for significant figure and 4th digit for number of zeros

For further marking information, please refer to data sheet "Chip resistors marking".

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Ni-barrier) are added. See fig.5

DIMENSIONS

Table 1 For outlines see fig. 5

TYPE	L (mm)	W (mm)	H (mm)	I_1 (mm)	I_2 (mm)
AH0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
AH0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
AH1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20

OUTLINES

For dimension see Table 1

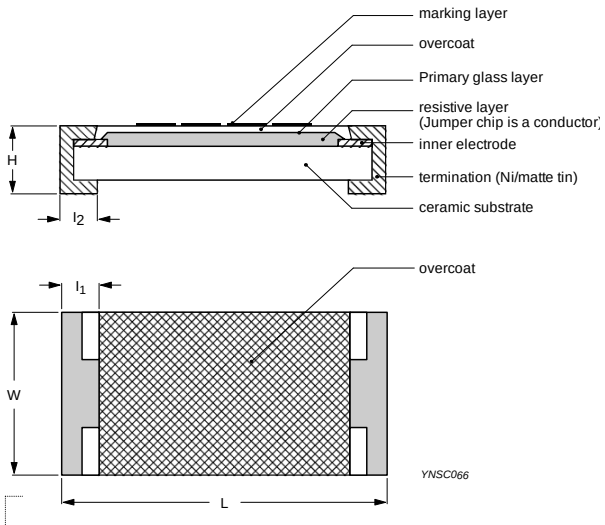

Fig. 5 Chip resistor outlines

ELECTRICAL CHARACTERISTICS

Table 2

TYPE	RESISTANCE RANGE	CHARACTERISTICS					
		Rated Power	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
AH0603	5% (E-24) 47Ω to 10MΩ 1% (E-24/E-96) 47Ω to 10MΩ 0.5% (E-24/E-96) 47Ω to 10MΩ	1/10W	–55 °C to +155 °C	350V	500V	500V	±200 ppm/°C
AH0805	5% (E-24) 47Ω to 22MΩ 1% (E-24/E-96) 47Ω to 22MΩ 0.5% (E-24/E-96) 47Ω to 10MΩ	1/8 W		400 V	800 V	800 V	
AH1206	5% (E-24) 47Ω to 27MΩ 1% (E-24/E-96) 47Ω to 27MΩ 0.5% (E-24/E-96) 47Ω to 15MΩ	1/4 W		500 V	1,000 V	1,000 V	

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	AH 0603	AH 0805	AH 1206
Paper/PE taping reel (R)	7" (178 mm)	5,000	5,000	5,000
Embossed taping reel (K)	7" (178 mm)	---	---	---

NOTE

1. For Paper/PE/Embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: –55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C:
AH0603=1/10W; AH0805=1/8W; AH1206=1/4W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

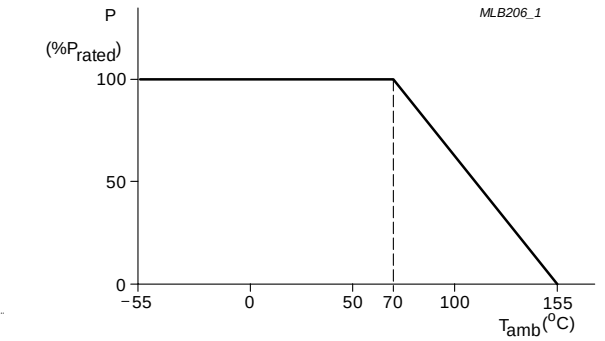

Fig. 6 Maximum dissipation (P_{max}) in percentage of rated power as a function of the operating ambient temperature (T_{amb})

$V = \sqrt{(P \times R)}$
or max. working voltage whichever is less

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

R = Resistance value (Ω)

Maximum working voltage can be applicable to resistors only if the resistance value is equal to or higher than the critical resistance value.

TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Operational Life/ Endurance	MIL-STD-202G-method 108A IEC 60115-1 4.25.1 JIS C 5202-7.10	1,000 hours at 70±5 °C applied RCWV 1.5 hours on, 0.5 hour off, still air required	±(2%+0.05 Ω)
High Temperature Exposure/ Endurance at upper category temperature	MIL-STD-202G-method 108A IEC 60115-1 4.25.3 JIS C 5202-7.11	1,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: 155±3 °C	±(1%+0.05 Ω)
Moisture Resistance	MIL-STD-202G-method 106F IEC 60115-1 4.24.2	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts Measurement at 24±2 hours after test conclusion	±(2%+0.05 Ω)
Thermal Shock	MIL-STD-202G-method 107G	-55/+125 °C Note: Number of cycles required is 300. Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(0.5%+0.05 Ω) for 10 KΩ to 10 MΩ ±(1%+0.05 Ω) for others
Short time overload	MIL-R-55342D-para 4.7.5 IEC60115-1 4.13	2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature	±(2%+0.05 Ω) No visible damage
Board Flex/ Bending	IEC60115-1 4.33	Device mounted on PCB test board as described, only 1 board bending required Bending for 0603 & 0805: 3mm 1206 & above: 2mm Holding time: minimum 60 seconds Ohmic value checked during bending	±(1%+0.05 Ω) No visible damage
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202 Method 103	1,000 hours; 85°C / 85% RH 10% of operating power Measurement at 24 ±4 hours after test conclusion	± (5.0%+0.05 Ω)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability			
- Wetting	IPC/JEDECJ-STD-002B test B IEC 60068-2-58	Electrical Test not required Magnification 50X SMD conditions: 1st step: method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	Well tinned (≥95% covered) No visible damage
- Leaching	IPC/JEDECJ-STD-002B test D IEC 60068-2-58	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	MIL-STD-202G-method 210F IEC 60068-2-58	Condition B, no pre-heat of samples Leadfree solder, 260 °C, 10 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1%+0.05 Ω) No visible damage
- FOS	ASTM-B-809-95* * Modified	Sulfur 750 hours, 105°C, unpowered	±(4.0%+0.05Ω)

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Sep. 10, 2020	-	- First issue of this specification